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RJK2006DPJ, RJK2006DPE, RJK2006DPF

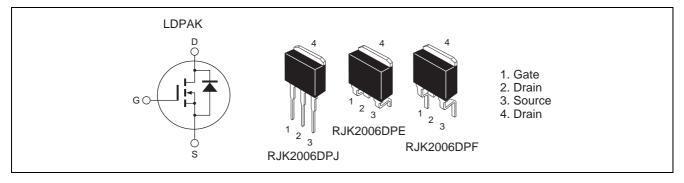
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G0512-0100 Rev.1.00 Jan.14.2005

Features

- Low on-resistance
- Low leakage current
- High speed switching

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

		(1a = 25 C)	
Item	Symbol	Ratings	Unit
Drain to Source voltage	V _{DSS}	200	V
Gate to Source voltage	V _{GSS}	±30	V
Drain current	I _D	40	А
Drain peak current	I _{D (pulse)} Note1	100	А
Body-Drain diode reverse Drain current	I _{DR}	40	А
Body-Drain diode reverse Drain peak current	Note1 I _{DR (pulse)}	100	А
Avalanche current	I _{AP} ^{Note3}	27	А
Avalanche energy	E _{AR} ^{Note3}	48.6	mJ
Channel dissipation	Pch ^{Note2}	100	W
Channel to case thermal impedance	θch-c	1.25	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 $\mu s,\,duty\,cycle \leq$ 1%

2. Value at Tc = $25^{\circ}C$

3. STch = 25° C, Tch $\leq 150^{\circ}$ C



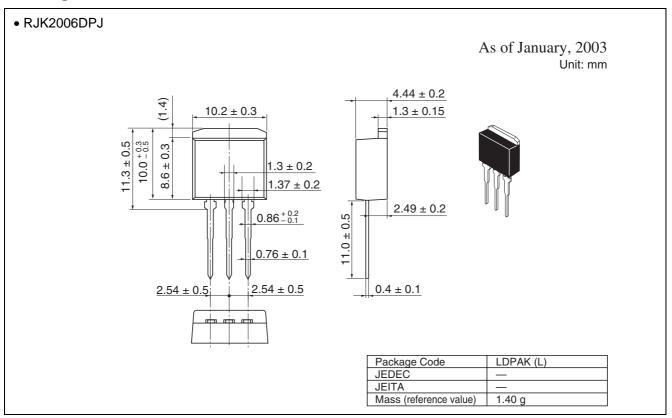
Electrical Characteristics

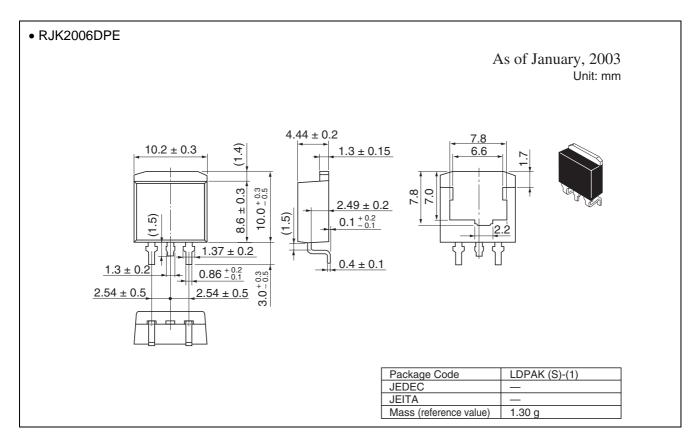
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to Source breakdown voltage	V _{(BR)DSS}	200	—		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Zero Gate voltage drain current	I _{DSS}	_	—	1	μΑ	$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0$
Gate to Source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$
Gate to Source cutoff voltage	V _{GS(off)}	3.0	—	4.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Forward transfer admittance	yfs	15	26	_	S	$I_D = 20 \text{ A}, V_{DS} = 10 \text{ V}^{Note}$
Static Drain to Source on state resistance	R _{DS(on)}	_	0.052	0.059	Ω	$I_D = 20 \text{ A}, V_{GS} = 10 \text{ V}^{Note2}$
Input capacitance	Ciss	_	1800	_	pF	V _{DS} = 25 V V _{GS} = 0 f = 1 MHz
Output capacitance	Coss	_	330	_	pF	
Reverse transfer capacitance	Crss	_	43	_	pF	
Turn-on delay time	td(on)	_	30		ns	I _D = 20 A V _{GS} = 10 V
Rise time	tr	_	180		ns	
Turn-off delay time	td(off)	_	85		ns	$R_L = 5 \Omega$
Fall time	tf	_	100		ns	Rg = 10 Ω
Total Gate charge	Qg	_	43		nC	$V_{DD} = 160 V$ $V_{GS} = 10 V$ $I_D = 40 A$
Gate to Source charge	Qgs	_	11	_	nC	
Gate to Drain charge	Qgd	_	20	_	nC	
Body-Drain diode forward voltage	V _{DF}	_	1.0	1.5	V	$I_F = 40 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-Drain diode reverse recovery time	trr		150	—	ns	I _F = 40 A, V _{GS} = 0 diF/dt = 100 A/μs
Body-Drain diode reverse recovery charge	Qrr	_	0.8	—	μC	

Notes: 4. Pulse test

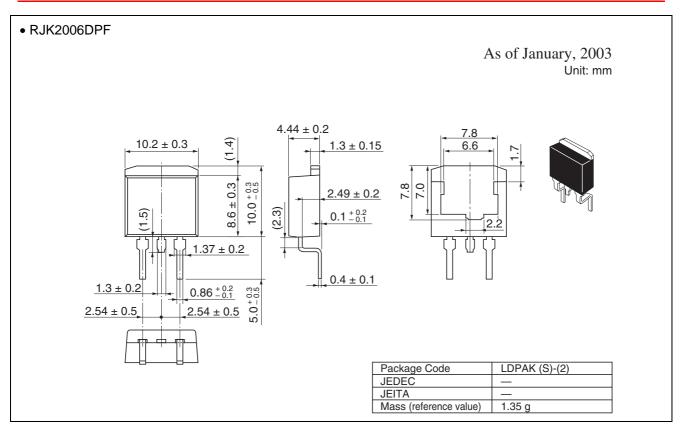


Package Dimensions









Ordering Information

Part Name	Quantity	Shipping Container
RJK2006DPE-TL-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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